# **CTM131 Series**

DC Input 5-Pin Mini-Flat Phototransistor Optocoupler

#### Features

- High isolation 3750 V<sub>RMS</sub>
- Multiple CTR selection available
- DC input with transistor output
- Creepage distance ≥5mm
- >0.4
- Operating temperature range 55 °C to 110 °C
- Halogen free compliance

## Description

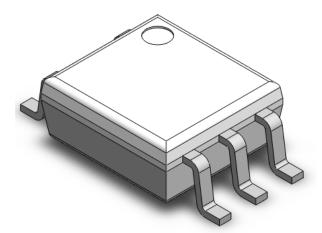
These series of general purpose optocoupler consists of a photo transistor optically coupled to a gallium arsenide Infrared-emitting diode in a 5-lead Mini-Flat package.

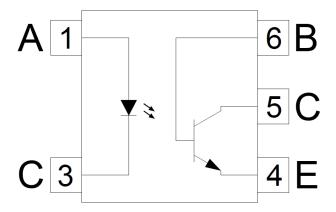
## Applications

- DC-DC Converters
- Programmable controllers
- Telecommunication equipment
- Hybrid substrates that require high density
  mounting

**Package Outline** 

## Schematic







DC Input 5-Pin Mini-Flat Phototransistor Optocoupler

# Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage	3750	Vrms	
T <sub>OPR</sub>	Operating temperature	-55 ~ +110	°C	
Tstg	Storage temperature	-55 ~ +150	°C	
TSOL	Soldering temperature	260	°C	
Ртот	Total power dissipation	200	mW	
Emitter				
l <sub>F</sub>	Forward current	50	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1µs P.W,300pps)	1	А	
VR	Reverse voltage	6	V	
PD	Power dissipation	70	mW	
Detector				
Pc	Power dissipation	150	mW	
B <sub>VCEO</sub>	Collector-Emitter Breakdown Voltage	80	V	
BVECO	Emitter-Collector Breakdown Voltage	7	V	
Вусво	Collector-Base Breakdown	80	V	
B <sub>VEBO</sub>	Emitter-Base Breakdown	7	V	
lc	Collector Current	50	mA	



### **Electrical Characteristics** $T_A = 25^{\circ}C$ (unless otherwise specified)

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF=10mA	-	1.24	1.4	V	
I <sub>R</sub>	Reverse Current	$V_R = 6V$	-	-	5	μA	
CIN	Input Capacitance	f= 1MHz	-	10	250	pF	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
BVCEO	Collector-Emitter Breakdown	I <sub>C</sub> = 500μA	80	-	-	V	
B <sub>VECO</sub>	Emitter-Collector Breakdown	I <sub>E</sub> = 100μA	7	-	-	V	
Вусво	Collector-Base Breakdown	I <sub>CB</sub> = 0.1mA	80			V	
BVEBO	Emitter-Base Breakdown	I <sub>EB</sub> = 0.1mA	7			V	
Iceo	Collector-Emitter Dark Current	V <sub>CE</sub> = 48V, I <sub>F</sub> =0mA	-	-	100	nA	
		V <sub>CE</sub> = 48V, I <sub>F</sub> =0mA, T <sub>A</sub> =85°C			50	μA	

#### **Transfer Characteristics**

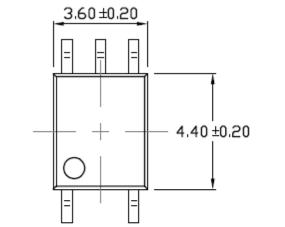
Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	Current Transfer Ratio	CTM131	I <sub>F</sub> = 5mA, V <sub>CE</sub> = 5V	50	-	600		
		CTM131A		50	-	150		
CTR		CTM131B		100	-	300	%	
		CTM131C		100	-	600		
		CTM131D		200	-	600		
V	Collector-Emitter Saturation		IF= 8mA, Ic= 2.4mA	-	-	0.4	V	
V <sub>CE(SAT)</sub>	Voltage		IF= 1mA, Ic= 0.2mA			0.4		
Rio	Isolation Resistance		V <sub>IO</sub> = 500V <sub>DC</sub>	5x10 <sup>10</sup>	-	-	Ω	
Cio	Isolation Capacitance		f= 1MHz	-	0.5	1	pF	

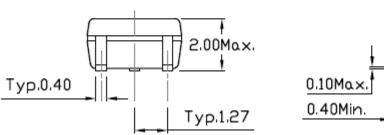
### Switching Characteristics

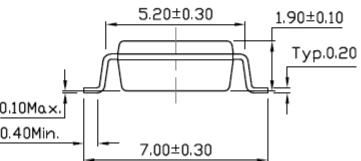
Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
tr	Rise Time	Ic= 2mA, Vcε= 2V, RL= 100Ω	-	6	18		
t <sub>f</sub>	Fall Time	1C = 2111A, VCE = 2V, RL = 10002	-	8	18	μs	



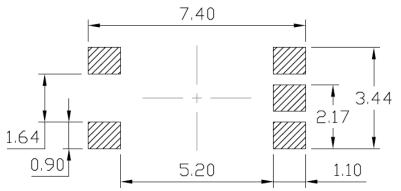
### Package Dimension Dimensions in mm unless otherwise stated







### Recommended Solder Mask Dimensions in mm unless otherwise stated





Note:

CT

131

R

Υ

Κ

WW

: Denotes "CT Micro"

: Manufacturing Code

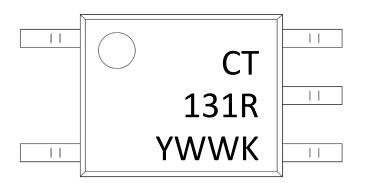
: Product Number

: CTR Rank

: Fiscal Year

: Work Week

## Marking Information



## **Ordering Information**

# CTM131R(Z)

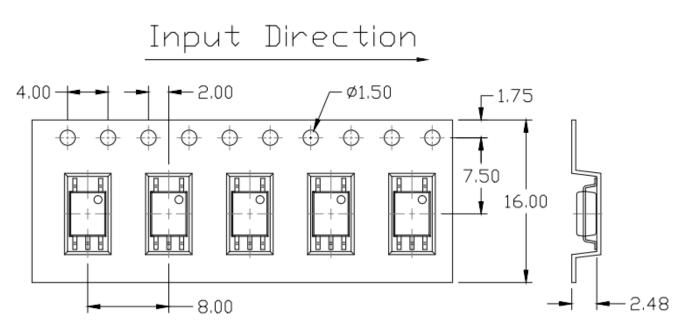
- CT = Denotes "CT Micro"
- M131 = Product Number
- R = CTR Rank (A,B,C,D or None)
- Z = Tape and reel option (T1, T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Tapping	3000 Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Tapping	3000 Units/Reel



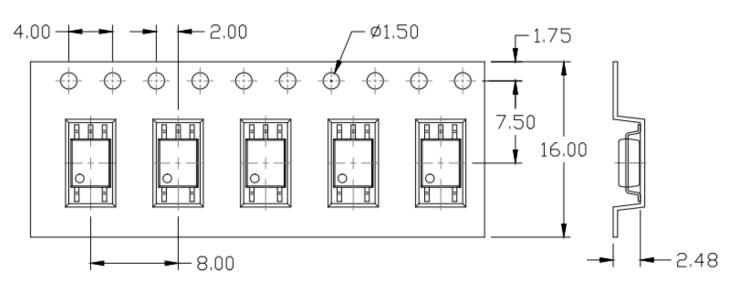
Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option T1



**Option T2** 

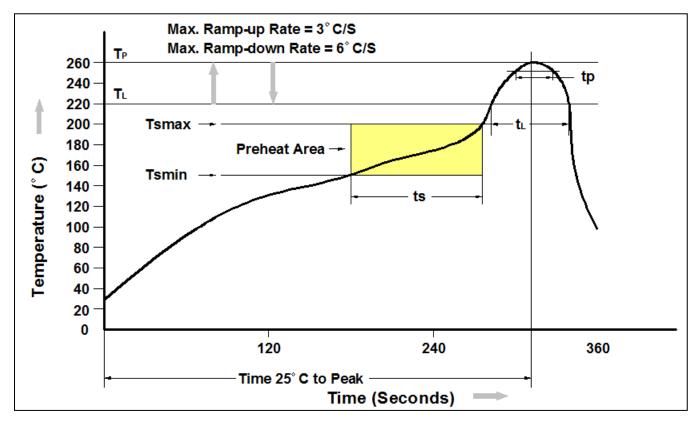






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### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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